

Sematech

**2nd International Extreme
Ultra-Violet Lithography
(EUVL) Symposium
2003**

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TABLE OF CONTENTS

Volume 1

Presentations

Welcome / Opening Remarks	1
<i>R. Hartman</i>	
Keynote speech.....	25
<i>C. Gwyn</i>	
Extreme Ultraviolet Sources for Lithography Application.....	67
<i>V. Banine</i>	
Laser-Produced-Plasma Light Source Development for EUVL at EUVA	83
<i>A. Endo</i>	
High Power Gas Discharge and Laser Produced Plasma Sources for EUVL.....	102
<i>U. Stamm</i>	
High Power Short Pulse and Cost Effective Laser Modules for Laser Produced Plasmas (LPP) EUV Source	136
<i>S. Ellwi</i>	
Power Scaling, Electrode Lifetime and Debris Mitigation of the Philips EUV Source	154
<i>J. Pankert</i>	
Advances in the Ion Beam Thin Film Planarization Process for Mitigating EUVL Mask Defects	174
<i>P. Mirkarimi</i>	
Advancements in ULE® Glass: CTE Metrology Capabilities and Material Properties	194
<i>K.E. Hrdina</i>	
EUV Mask and Blanks Development at HOYA	219
<i>T. Shoki</i>	
Actinic Mask Metrology for EUVL	236
<i>H. Kinoshita</i>	
Technology Steps to the Pilot Production of EUV Mask Blanks in 2005	255
<i>F. Sobol</i>	
Resist Characterization for EUVL.....	267
<i>W.F. Domke</i>	
Inband EUV Open Frame Resist Exposure TEUVL.....	308
<i>R. Lebert</i>	

Absorbance Measurement of Polymers at EUV Wavelength: Correlation between Experimental and Theoretical Calculations	333
<i>Y.J. Kwark</i>	
Patterning Capabilities of EUV Resists	350
<i>H. Cao</i>	
Resist Exposure Characteristics of EUV Resists	364
<i>T. Watanabe</i>	
Effect of Polymer Molecular Weight on AFM Polymer Aggregate Size and LER of EUV Resists	381
<i>R. Brainard</i>	
SPECIAL TALK - International Cooperation on EUVL Development: The International EUV Initiative (IEUVI).....	402
<i>P. Gargini</i>	
Evaluation of the Critical Dimension Control Requirements in the ITRS Using Statistical Simulation and Error Budgets.....	427
<i>S. Hector</i>	
Throughput Model Consideration and Impact of Throughput Improvement Request on Exposure Tool	448
<i>K. Ota</i>	
ASML's EUVL Program Progress Update.....	464
<i>N. Harned</i>	
Updates on Engineering Tests Stand (ETS): Lithographic and Tool Learning	485
<i>S. Lee</i>	
Advances in EUVL Development for Sub-50nm DRAM Nodes	506
<i>S. Hirscher</i>	
Damage Free and Dry Removal of Nano-size Inorganic Particles from EUV Mask Layers by laser Induced Shockwaves	527
<i>J.G. Park</i>	
Optimized Absorber-Stack Processes for EUV Masks	552
<i>C. Hofeld</i>	
Low-defect Coating Technology for the Production of Masks Blanks for EUVL	564
<i>R. Randive</i>	
Tiling-based Flare Compensation for EUVL.....	586
<i>J. Cobb</i>	
Particle-free EUV Reticle Handling and Storage.....	604
<i>H. Werij</i>	

Volume 2

Investigation of Oxidation Resistance of EUV Multilayers	626
<i>S. Bajt</i>	
Progress in EUV Optics Life Time Expectations	647
<i>M. Weiss</i>	
Investigation of Contamination Removal from EUVL Mask	659
<i>K. Hamamoto</i>	
Study of Ion Damage on EUV Light Source Collector Mirrors	677
<i>H. Komori</i>	

Study of EUV Source Collector Damage Mechanism.....	699
<i>J. Gillaspy</i>	
Recent Observation of Condenser Erosion in the ETS.....	725
<i>L.E. Klebanoff</i>	
The Case for Tin as an EUV Source.....	738
<i>M. Richardson</i>	
Progress of Tin Plasma Technologies at AIST	766
<i>T. Tomie</i>	
Development of High Conversion Efficiency High Power EUV Sources for Lithography	790
<i>V. Borisov</i>	
Japan MEXT Leading Project for Laser-Produced Plasma EUV Light Source Development.....	810
<i>K. Nishihara</i>	
Secondary-Plasma-Based Debris Mitigation for Next Generation EUVL Source.....	827
<i>D. Ruzic</i>	
Studies on x-ray Conversion Efficiency in Xe Cryogenic Targets.....	867
<i>T. Mochizuki</i>	
The EUV Optics Development Program at Carl Zeiss SMT AG	879
<i>P. Kürz</i>	
EUV Projection Optics and Active Mirror Development at SAGEM	900
<i>R. Geyl</i>	
Visible-Light Alignment of the MET Projection Optics	917
<i>J.S. Taylor</i>	
Measurement of the Impact of Flare on Line Width Roughness and Correlation with Aerial Image Metrics	940
<i>M. Chandhok</i>	
Smoothing of the Substrate Surface by Mo/Si Multilayer Coating Deposited Using Ion Beam Sputtering	955
<i>N. Kandaka</i>	
Metrology for EUVL Sources	974
<i>M. Schürmann</i>	
The Experimental EUV Interferometer with Several Measurement Methods.....	992
<i>C. Ouchi</i>	
At-wavelength Interferometry of the 0.3 NA MET Optics	1008
<i>K. Goldberg</i>	
Development of EUV-Scatterometry for CD Characterization of Masks	1044
<i>F. Scholze</i>	
NIST EUVL Metrology Programs	1058
<i>S. Grantham</i>	
CLOSING REMARKS.....	1078
<i>R. Hartman</i>	

Posters

Short Term Vacuum Outgassing Measurement by the Pressure Rise Method.....	1093
<i>Anthony M. Keen</i>	

PPT (10-9mbar) Sensor for Organic Contamination Detection in Next Generation Lithography Tools.....	1094
<i>Robert B. Grant</i>	
Quasi Steady-state Measurements of Sub 1-minute Vacuum Outgassing Rates & Application to EUV Photoresists.....	1095
<i>Neil Condon</i>	
Optics Contamination Under Pulsed EUV Radiation	1096
<i>Bas Mertens; Vadim Banine; Markus Weiss</i>	
The Optics Contamination/Lifetime Program: An Overview of Supporting Facilities.....	1097
<i>Bas Mertens; Markus Weiss; Hans Meiling; Roman Klein; Eric Louis; Peer Zalm</i>	
Evaluation of Contamination Deposition on Pinholes Used in EUV Wavefront Metrology	1098
<i>K. Sugisaki; M. Niiba</i>	
Analysis of Uneven EUV Mask Structure	1113
<i>Jong Hoi Kim</i>	
Effect of EUV Light Scattering from the Rough Absorber and Buffer Side	1125
<i>Yeong-Keum Kwan</i>	
Atomistic Investigation of the Si/Mo (110) Interface for EUV Reflectors	1141
<i>In-Yang Kang</i>	
Evaluation of Property Change by the Insertion of Ru Layer into Mo/Si Multilayer	1142
<i>Jin-Ho Ahn</i>	
Current Efforts Towards Standardization of EUVL Mask (Reticles)	1158
<i>Brian Blum; Scott Hector</i>	
Detection of Buried Defect Using Actinic Darkfield Microscopy	1159
<i>W. Farys; P. Schiavone; F. Pollock; C. Vannuffel; M. Bertolo</i>	
Development of a New Stripping Process for EUV Masks	1160
<i>C. Charpin Nicolle</i>	
Impact of Flatness Correction Technologies on the Quality of EUVL Masks Blank Substrates.....	1161
<i>Frauke Ruggeberg</i>	
Development of Modified Zero Expansion Ti-dope Silica Glass for EUVL Substrate.....	1162
<i>Yasutomo Iwahashi</i>	
An Ellipsometric Picometer Sputtering-Rate Monitor for Exact EUV Multilayer Fabrication	1175
<i>Masaki Yamamoto</i>	
Correlation Between Printability and Visibility of Defects in EUV Mask Blanks	1177
<i>Masaaki Ito; Toshihisa Tomie</i>	
Visible Light Inspection of Mo/Si Multilayer Mask Blanks.....	1189
<i>Takao Hashimoto</i>	
Characteristics of TaGeN Films for EUVL Mask Absorber	1205
<i>Yuusuke Tanaka</i>	
Evaluation of Pattern Fidelity on Reflectance of Absorber Surface	1218
<i>Minoru Suguwara</i>	

Efficient Simulation of Multilayer Defects on 2D and 3D EUV Masks	1234
<i>Peter Evanschitzky; Thomas Schmoller</i>	
Mask Induced Imaging Artifacts in Extreme Ultraviolet Lithography.....	1235
<i>Andreas Erdmann; Thomas Schmoller</i>	
Mo/Si Multilayers with Arbitrary Period Thickness Distribution.....	1236
<i>S. Braun</i>	
Volume 3	
Defect Repair for EUVL Mask Blanks.....	1237
<i>Stefan P. Hau-Riege; Eric Gullickson; Daniel G. Stearns</i>	
High Accuracy Measurement of Thermal Expansion.....	1254
<i>J. Alkemper; L. Aschke; J. Schwider</i>	
Large Area Sputtering System for EUVL Optics.....	N/A
<i>Torsten Feigl</i>	
Vector Diffraction Simulation for EUV Mask Illuminated by Focused Waves	1255
<i>Seong-Sue Kim</i>	
High-Speed EUV-Reflectrometer for Mask-Blank Inspection	1269
<i>Ranier Lebert; Lutz Aschke; Gerhard Ulm; Konstantin Walter</i>	
EUV Mask Development at LETI: Latest Results	1278
<i>J. Hue</i>	
Sagem Progress on EUV Mask Substrates Polishing.....	1279
<i>Roland Geyl</i>	
Initial Results of Photomask-Blank Deposition Tool	1280
<i>Michael D. Kriese</i>	
A New Absorber Material Enables EUV Masks with Enhanced Etch Conotrol and CD Uniformity	1281
<i>Frank Sobel; Florian Letzkus; Jenspeter Rau</i>	
Nanoscale Surface Cleaning of EUV Reticles	1282
<i>Ashmed A. Busnaina et al (Northeastern University); JinGoo Park (Hanyang University); Arun Ramamoorthy et al (Intel Corporation)</i>	
At-wavelength Defect Inspection of EUV Mask Blanks.....	1283
<i>Anton Barty; Yanwei Liu; Phil Seidel</i>	
Progress in EUV Mask Manufacture to Meet P37/P38 Specifications	1284
<i>C.C. Walton; D.W. Pettibone; Phil Seidel</i>	
In Situ-Ellipsometric Investigation of Mo-Si Multilayer Growth for EUV Mask Blank Manufacturing	1300
<i>E. Schubert</i>	
Non-Linearitys in Photodiode Response at High Intensities	1301
<i>C. Tarrio</i>	
Development and AIMST EUV at Carl Zeiss	1313
<i>Karl-Heinz Bechstein</i>	
Table-top Laser-based EUV Source for Metrology	1321
<i>K. Mann</i>	
Commercial EUV Source for At-Wavelength Metrology	1322
<i>A. Egbari; S. Becker</i>	

Compact In-line EUV Laser Plasma Reflectometer for the Measurement Reflectivity and Uniformity of EUV Lithography Mask Blank Multilayer Coatings	1332
<i>Rupert Perrera</i>	
Novel Instrumentation for In- and Out of Band Metrology of EUVL Sources	1357
<i>L.A. Shmaenok; N.N. Salashchenko; V.L. Sukhanov; V. Banine</i>	
Aerial Image Simulations using ETS-POB2 Interferometer Data	1370
<i>Marcel Dierche</i>	
Performance of the IWS EUV Reflectometer using LPP Source	1371
<i>Ludwig van Loyer; Frank Scholze; Holtger Stiel; Christian Rempel; Stephen Mullender</i>	
Recent Advances of the Visible Point Diffraction Interferometer for EUVL Aspheric Mirrors	1372
<i>K. Otaki</i>	
Comparison of Techniques to Measure the Point Spread Function due to Scatter and Flare in EUVL Systems	1388
<i>Manish Chandhok</i>	
Characterization of the Spatial Aspects of Line Edge Roughness.....	1404
<i>V. Constandoudis</i>	
Characterization of Outgassing for EUV Technology	1405
<i>Wang Yueh; Victoria Golovkina</i>	
Inband EUV Open Frame Resist Exposure TEUVL.....	1417
<i>Rainer Lebert; Karl Kragler</i>	
Techniques for Directly Measuring the Absorbance of Photoresists at EUV Wavelengths	1426
<i>Manish Chandhok; Erik Gullickson; Robert Brainard</i>	
Origins of Photoresist Roughness: Monte Carlo Simulation of the Development Process and Scaling Analysis	1441
<i>G.P. Patsis</i>	
EUVL Source Optimisation for 13.5nm Operation	1442
<i>A. Cummings</i>	
The Generation of EUV Light with a Compact ECR Source	1443
<i>K.N. Leung; Q. Ji; D. Schneider; Vivek Bakshi</i>	
Extreme Ultra-Violet Generation Pumped by CO₂ Laser Produced Plasma.....	1444
<i>Akihiko Takahashi</i>	
Development of a Laser Produced Plasma Source for Extreme Ultra Violet Lithography	1458
<i>C. Soullie</i>	
Characteristics of Capillary Z-pinch Discharge Light Source.....	1459
<i>Eric Hotta</i>	
Theoretical Spectroscopy of the EUV Emission of Xe and Sn.....	1479
<i>Akira Sasaki; Fumihiko Koiki; Katsunobu Nishibara</i>	
EUV Yield Enhancement Due to Propagating Shockwaves in laser Plasma Sources	1502
<i>Rene de Brujin</i>	
Atomic Model and Equation of State fo Hydrodynamic Simulation of Laser Plasma Sources	1503
<i>Takeshi Nishikawa; Hiroyuki Furukawa; Katsunobu Nishihara</i>	

Radiation Characteristics of a Capillary Z-pinch EUV Source	1512
<i>Yusuka Teramoto</i>	
Radiation Hydrodynamic Simulations of Laser-Produced Plasma for EUVL	1530
<i>Atushi Sunahara; Takeshi Nishikawa; Masakatsu Murakami</i>	
Z-pinch EUV Source Driven by a 1W Blumlein Generator	1550
<i>Sunao Katsuki; Takashi Sakugawa</i>	
Rotating Cryogenic Drum for Continuous Supply of Solid Xe Target.....	1569
<i>Keisuke Fukkugaki</i>	
The Pinch Plasma of the Philips Extreme UV Source	1580
<i>Thomas Krucken</i>	
Dependence of EUV Emission Properties on Drive Laser Wavelength	1581
<i>M. Yamaura; M. Nakai; T. Nishikawa</i>	
Fabrication of Porous Tin (IV) Oxide as a Laser-Plasma EUV Source Target	1598
<i>K. Nagai</i>	
Detailed Analysis of the Optical Scheme for the EXULITE LLP Source.....	1599
<i>P.Y. Thro</i>	
Modular Laser-Plasma EUV Power Source for Micro-Lithography	1600
<i>Benoit Barthod; J. Skrzypozak; C. Bonnefoy</i>	
Thermal and Fluid Modeling for the EXULITE LLP Source.....	1601
<i>Benoit Barthod</i>	
Ionization & Excitation Rate Coefficient Calculation for Plasma Emitting in EUV Range	1602
<i>Vassili S. Zakharov</i>	
EUV-Technology with Discharge "EUV-Lamp"	1620
<i>Rainer Lebert</i>	
Experimental Study on Basic Properties of Laser-Produced Plasma as an EUV Source on GEKKO XII	1638
<i>M. Nakai; S. Uchida; T. Nishikawa</i>	
Characterization of EUV Emission from Laser Produced Low-Density Tin-Oxidized Plasmas.....	1657
<i>H. Nishimura; M. Yamaura; T. Nishikawa</i>	
Laser Heating of Noble Gas Droplet Sprays: EUV Source Efficiency Considerations	1665
<i>H.M. Milchberg</i>	
Performance Evaluation on Discharge and Laser Based EUV Sources Using Z 2-D Radiation MHD Modeling.....	1682
<i>S.V. Zakharov; V.G. Novikov; A.Y. Kroukovski; K.D. Ware</i>	
The SOARING High Repetition Rate EUV Source.....	1703
<i>Peter Choi; Mario Ravre; Vladimir Novikov; An Yuan</i>	
Modeling of Xenon EUV Emission Spectra & MHD Plasma Parameters for a DPF Light Source	1726
<i>N. Bowering; M. Martins</i>	
EXCITE A MEDEA+ Extreme UV Consortium for Imaging Technology.....	1742
<i>Peter Zandbergen; Wolf-Dieter Domke; Peitro Cantu; Andreas Wild; Jean-Yves Robic</i>	
EUV Microexposure Capabilities at the ALS using the 0.3-NA MET Optic	1743
<i>Patric Nalleau; Carl Chumg</i>	

Evaluation of Low-Expansion, Electrostatic Clamp Materials for EUVL.....	1744
<i>J. van Elp</i>	
Electrostatic Pin Chucks from "Zero Expansion" Materials.....	1745
<i>G. Kalkowski; S. Russe</i>	
Particle-Induced Distortion in EUVL Reticles during Exposure Chucking.....	1746
<i>Eric Cotte; Thomas White</i>	
Influence of Reticle Thickness on Image Placement Accuracy.....	1760
<i>Liang Zheng; Thomas White</i>	
EUVL Mask Flatness and Electrostatic Chucking Analysis	1775
<i>Andrew Mikkelsen; Kenneth Bledsel</i>	
EUV Lithography Applied to the Coloration of LIF for Photonics	1790
<i>Giuseppe Baldacchini; Anatoly Faenov; Tania Limongi</i>	
Fabrication and Alignment of 10X-Schwarzchild Optics for F2X Experiments.....	1808
<i>Song Lee; Lou Marchetti; Michael Shumway; Donald Phillion</i>	
Status of the Micro Exposure Tool for EUV Microsteppers.....	1824
<i>Eric Sohment; Koen van Ingen Schenau; Ralf Muller</i>	
ESH Assessment of EUV Lithography.....	1825
<i>Walter Worth</i>	
Microstepper for EUV Lithography	1843
<i>Philipp Grunewald</i>	
Author Index	